

tML® - Module Blind Plate 5HP for Rack Mount Enclosure 19"/3U



tML® tde Modular Link

tML® is a patented, modular cabling system consisting of the three key components module, trunk cable and rack mount enclosure. The system components are 100 percent manufactured, pre-assembled and tested in Germany. They enable plug-and-play installation on site – especially in data centres, but also in industrial environments – within the shortest possible time. Heart of the system are the rear MPO/MTP® and Telco connectors, which can be used to connect at least six or twelve ports at a time. Depending on the module configuration, transfer rates of up to 400G are currently possible with SR4. The fibre optic and TP modules can be used together in a module carrier with a very high port density. The tde offers its tML® cabling system as a proven tML® standard system and in the highly innovative variants tML® 12, tML® 24, tML® 32 and now tML® 24+ System for extreme scalability and very easy migration to higher transmission rates such as 40G, 100G, 200G, 400G and 800G and more.

The tML® - Module Blind Plate is intended for the cover of unused slots in the tML® - Rack Mount Enclosure 3U (for 17 x Modules).



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tML[®] - Module Blind Plate 5HP for Rack Mount Enclosure 19"/3U

Technical Data

Material	stainless steel
Mounting method	Assembly at the Front of the tML [®] - Rack Mount Enclosure with two screws.
	QS-Managementsystem ISO 9001, ISO 14001 and TL 9000

Product variants & accessories

Art.-No.	Description
TML-T-BLIND	tML [®] - Module Blind Plate 5HP for Rack Mount Enclosure 19"/3U